

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JUSTIN R. HAWKES	10/11/2013
ANDRZEI E. KUCZEK	10/11/2013
RAJA KOUNTANYA	10/11/2013
DARYL J. MICHAUD	10/11/2013
RECEIVING PARTY DATA	
Name:	UNITED TECHNOLOGIES CORPORATION
Street Address:	1 FINANCIAL PLAZA
City:	HARTFORD
State/Country:	CONNECTICUT
Postal Code:	06103
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14567555
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Email:	christopher.lyle@klgates.com
Correspondent Name:	K&L GATES, LLP
Address Line 1:	1 PARK PLAZA
Address Line 2:	12TH FLOOR
Address Line 4:	IRVINE, CALIFORNIA 92614
ATTORNEY DOCKET NUMBER:	0244856.00039
NAME OF SUBMITTER:	JOHN P. TERESINSKI
SIGNATURE:	/John P. Teresinski/
DATE SIGNED:	12/30/2014
Total Attachments: 3	
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ASSIGNMENT BY INVENTORS

THIS ASSIGNMENT, made by Justin R. HAWKES, whose mailing address is: c/o United Technologies Corporation, 1 Financial Plaza, Hartford, CT 06103; Andrzej E. KUCZEK, whose mailing address is: c/o United Technologies Corporation, 1 Financial Plaza, Hartford, CT 06103; Raja KOUNTANYA, whose mailing address is: c/o United Technologies Corporation, 1 Financial Plaza, Hartford, CT 06103; and Daryl J. MICHAUD, whose mailing address is: c/o United Technologies Corporation, 1 Financial Plaza, Hartford, CT 06103; (hereinafter referred to as Assignors)

WHEREAS, Assignors have invented certain new and useful improvements in **MACHINE FOR DEEP ROLLING TOOL POSITIONING**, set forth in a Patent application for Letters Patent of the United States, already filed on December 11, 2014 as U.S. Application Serial No. 14/567,555; and

WHEREAS, United Technologies Corporation, 1 Financial Plaza, Hartford, CT 06103 USA (hereinafter referred to ASSIGNEE), is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignors, as joint inventors as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, their successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other International agreements to

which the United States of America adheres, and to any other benefits accruing or to accrue to me individually and/or jointly with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and Assignors hereby authorize and request the Commissioner of Patents to issue the United States Letters Patent to said ASSIGNEE the whole right, title and interest thereto;

AND Assignors further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or their designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

AND Assignors further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at their own expense;


AND Assignors further agree that ASSIGNEE will, upon request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

AND Assignors hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

AND Assignors hereby authorize and requests the attorneys of record in this application to insert the execution date, serial number and filing date of this application in the spaces that follow:

Application Serial Number: 14/567,555 Filing Date: December 11, 2014

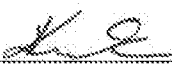
This assignment is being executed on the date indicated below.



Dated: 10/11/13

Justin R. HAWKES


This assignment is being executed on the date indicated below.



Dated: 10/11/2013

Andrzej E. KUCZEK

This assignment is being executed on the date indicated below.



Dated: 10/11/2013

Raja KOUNTANYA

This assignment is being executed on the date indicated below.



Dated: 10/11/2013

Daryl J. MICHAUD